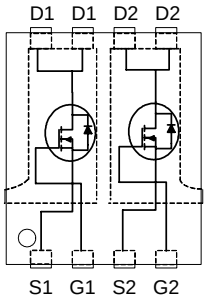
XP6A038MT

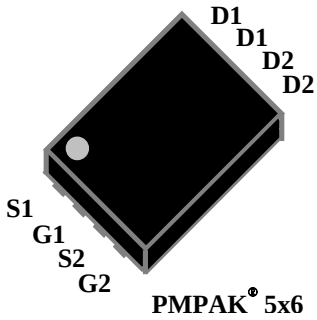
Halogen-Free Product

DUAL N-CHANNEL ENHANCEMENT MODE POWER MOSFET

- **Simple Drive Requirement**
- **Fast Switching Characteristic**
- **RoHS Compliant & Halogen-Free**



BV_{DSS}	60V
$R_{DS(ON)}$	38mΩ



Description

XP6A038 series are innovated design and silicon process technology to achieve the lowest possible on-resistance and fast switching performance. It provides the designer with an extreme efficient device for use in a wide range of power applications.

The PMPAK ® 5x6 package is special for voltage conversion application using standard infrared reflow technique with the backside heat sink to achieve the good thermal performance.

Absolute Maximum Ratings@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Rating	Units
V_{DS}	Drain-Source Voltage	60	V
V_{GS}	Gate-Source Voltage	±20	V
I_D@T_C=25℃	Drain Current, V_{GS} @ 10V	16.2	A
I_D@T_A=25℃	Drain Current, V_{GS} @ 10V[3]	6.7	A
I_D@T_A=70℃	Drain Current, V_{GS} @ 10V[3]	5.3	A
I_{DM}	Pulsed Drain Current[1]	30	A
P_D@T_A=25℃	Total Power Dissipation	3.57	W
E_{AS}	Single Pulse Avalanche Energy[4]	18	mJ
T_{STG}	Storage Temperature Range	-55 to 150	℃
T_J	Operating Junction Temperature Range	-55 to 150	℃

Thermal Data

Symbol	Parameter	Rating	Units
Rthj-c	Maximum Thermal Resistance, Junction-case	6	℃/W
Rthj-a	Maximum Thermal Resistance, Junction-ambient[3]	35	℃/W

Electrical Characteristics@T_j=25°C(unless otherwise specified)

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_D=250uA	60	-	-	V
$R_{DS(ON)}$	Static Drain-Source On-Resistance[2]	V_{GS}=10V, I_D=7A	-	-	38	mΩ
		V_{GS}=4.5V, I_D=4A	-	-	55	mΩ
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_D=250uA	1.3	-	3	V
g_{fs}	Forward Transconductance	V_{DS}=5V, I_D=7A	-	22	-	S
I_{DSS}	Drain-Source Leakage Current	V_{DS}=48V, V_{GS}=0V	-	-	25	uA
I_{GSS}	Gate-Source Leakage	V_{GS}=±20V, V_{DS}=0V	-	-	±0.1	uA
Q_g	Total Gate Charge[5]	I_D=7A	-	20	32	nC
Q_{gs}	Gate-Source Charge[5]	V_{DS}=30V	-	5	-	nC
Q_{gd}	Gate-Drain ("Miller") Charge[5]	V_{GS}=10V	-	4	-	nC
$t_{d(on)}$	Turn-on Delay Time[5]	V_{DS}=30V	-	9	-	ns
t_r	Rise Time[5]	I_D=1A	-	5.5	-	ns
$t_{d(off)}$	Turn-off Delay Time[5]	R_G=3.3Ω	-	23	-	ns
t_f	Fall Time[5]	V_{GS}=10V	-	8	-	ns
C_{iss}	Input Capacitance[5]	V_{GS}=0V	-	1150	1840	pF
C_{oss}	Output Capacitance[5]	V_{DS}=25V	-	70	-	pF
C_{rss}	Reverse Transfer Capacitance[5]	f=1.0MHz	-	52	-	pF
R_g	Gate Resistance	f=1.0MHz	-	2	4	Ω

Source-Drain Diode

Symbol	Parameter	Test Conditions	Min.	Typ.	Max.	Units
V_{SD}	Forward On Voltage[2]	I_S=2.9A, V_{GS}=0V	-	-	1.3	V
t_{rr}	Reverse Recovery Time[5]	I_S=7A, V_{GS}=0V	-	14	-	ns
Q_{rr}	Reverse Recovery Charge[5]	dI/dt=100A/μs	-	8	-	nC

Notes:

1.Pulse width limited by Max. junction temperature.

2.Pulse test

3.Surface mounted on 1 in^2 copper pad of FR4 board, t ≤10sec ; 85 ℃/W on steady state.

4.Starting T_j=25°C , V_{DD}=30V , L=1mH , R_G=25Ω , V_{GS}=10V , I_{AS}=6A

5.Guaranteed by design.

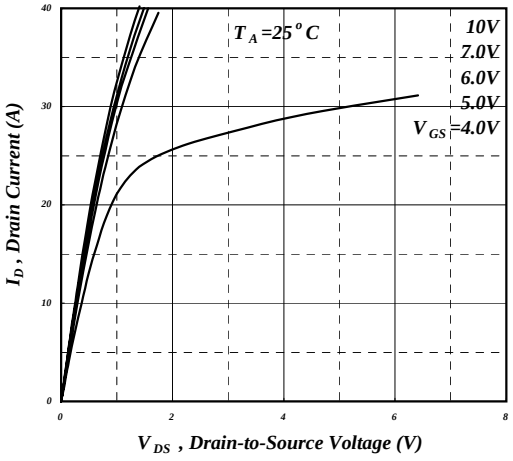


Fig 1. Typical Output Characteristics

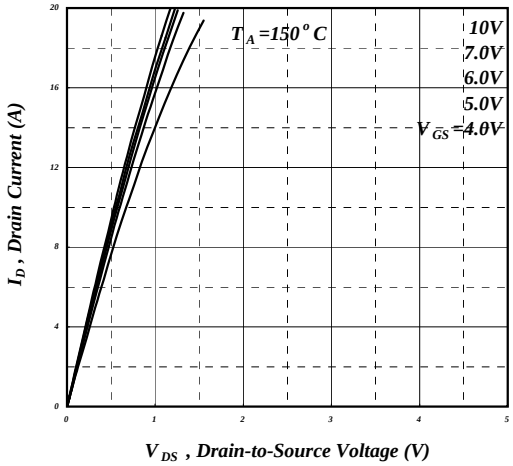


Fig 2. Typical Output Characteristics

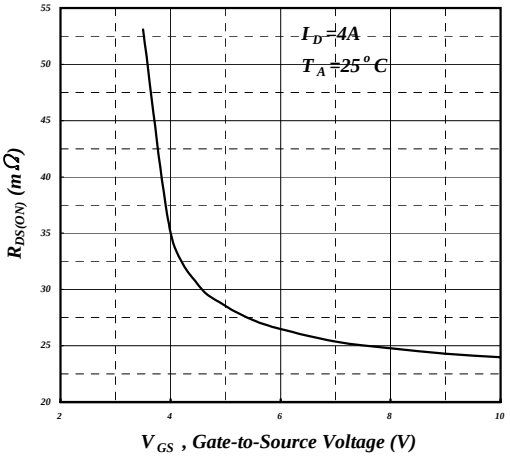


Fig 3. On-Resistance v.s. Gate Voltage

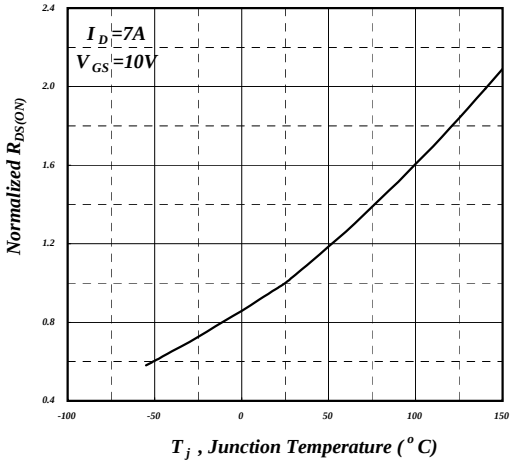


Fig 4. Normalized On-Resistance v.s. Junction Temperature

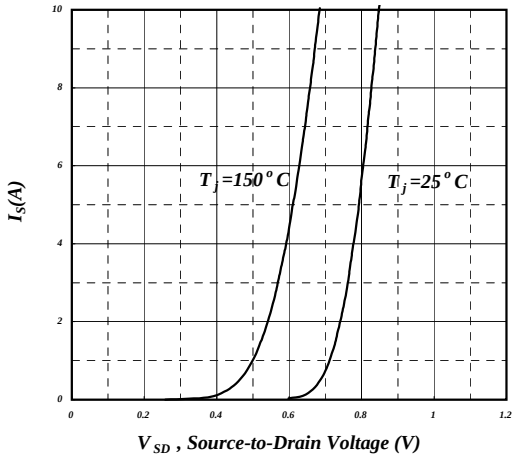


Fig 5. Forward Characteristic of Reverse Diode

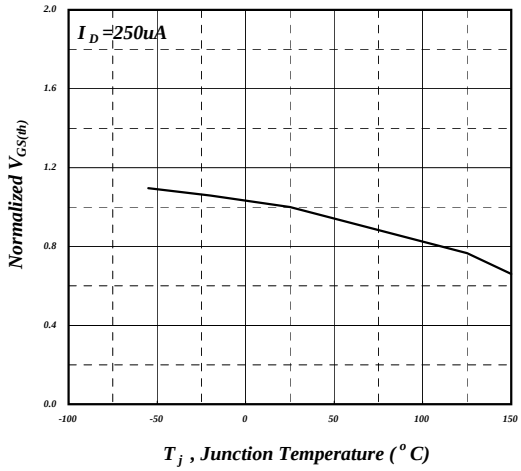


Fig 6. Gate Threshold Voltage v.s. Junction Temperature

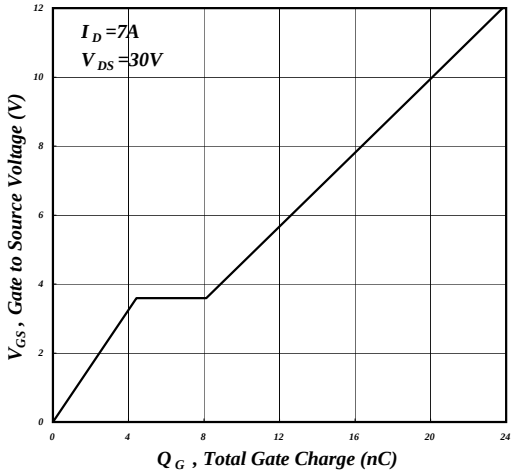


Fig 7. Gate Charge Characteristics

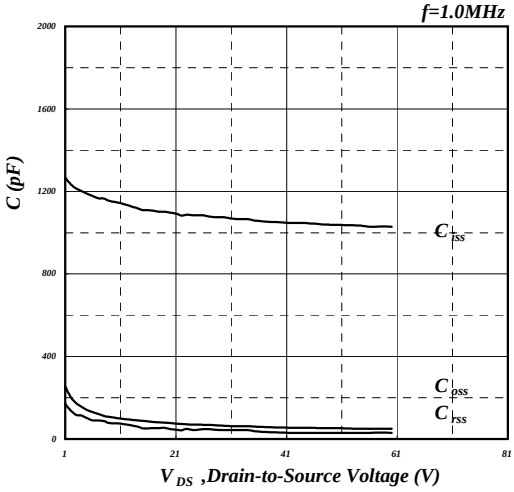


Fig 8. Typical Capacitance Characteristics

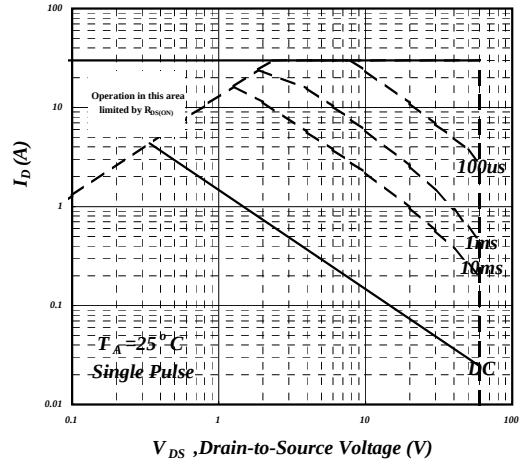


Fig 9. Maximum Safe Operating Area

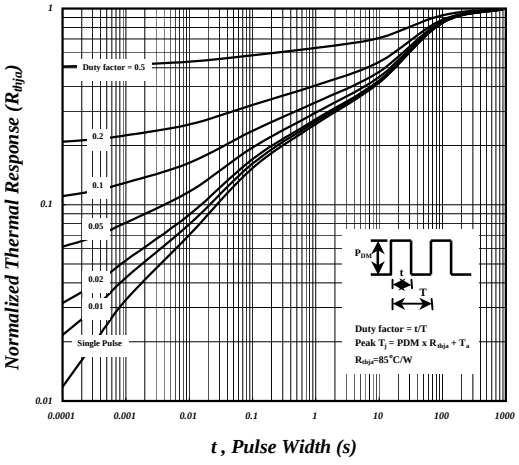


Fig 10. Effective Transient Thermal Impedance

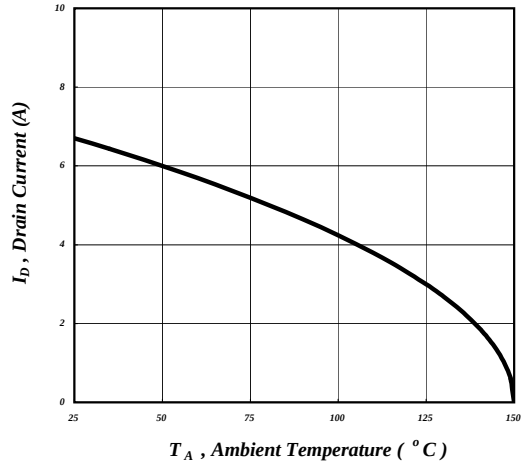


Fig 11. Drain Current v.s. Ambient Temperature

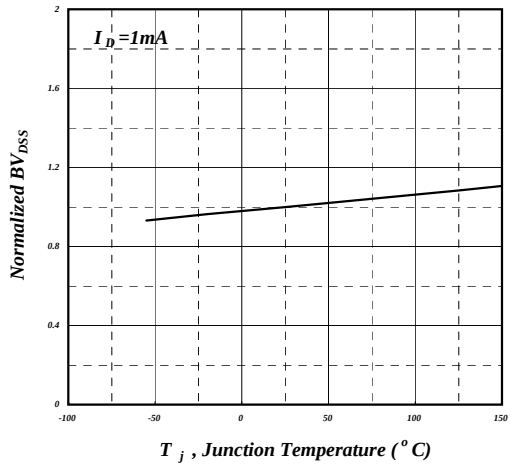
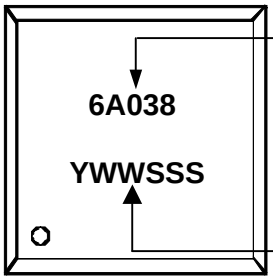


Fig 12. Normalized BV_{DSS} v.s. Junction Temperature

MARKING INFORMATION



Part Number

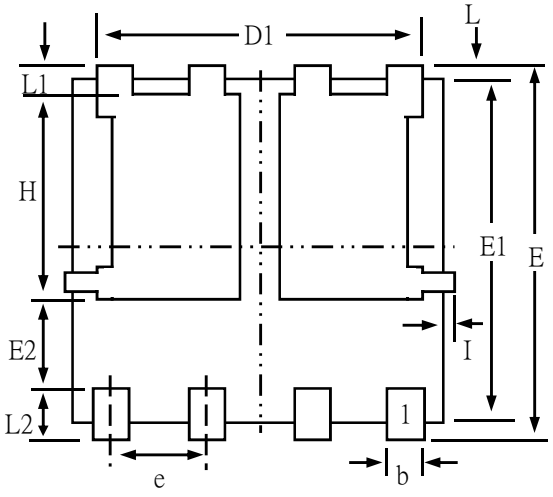
Date Code (YWWSSS)

Y：Last Digit Of The Year

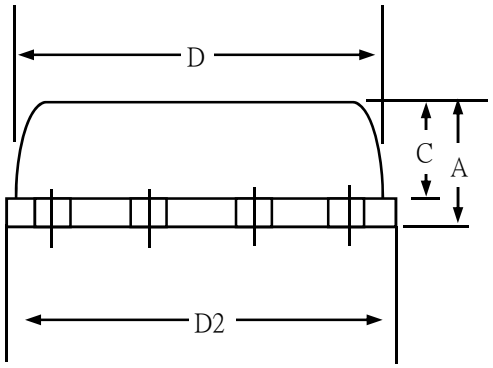
WW：Week

SSS：Sequence

Package Outline : PMPAK 5x6 (Dual Pad)



BACKSIDE VIEW



SYMBOLS	Millimeters		
	MIN	NOM	MAX
A	0.80	1.00	1.20
b	0.34	0.42	0.50
C	0.54	0.76	0.97
D	4.80	4.95	5.10
D1	4.11	4.21	4.31
E	5.90	6.05	6.20
E1	5.60	5.75	5.90
E2	1.60 (ref.)		
e	1.27 (ref.)		
L	0.05	0.15	0.25
L1	0.60 (ref.)		
L2	0.60 (ref.)		
H	3.60 (ref.)		
I	0.15 (ref.)		
D2	4.80	5.15	5.50

1.All Dimension Are In Millimeters.

2.Dimension Does Not Include Mold Protrusions.

Draw No. M2-1MT8-G-v02

PMPAK5X6(Dual Pad,左右) FOOTPRINT：